



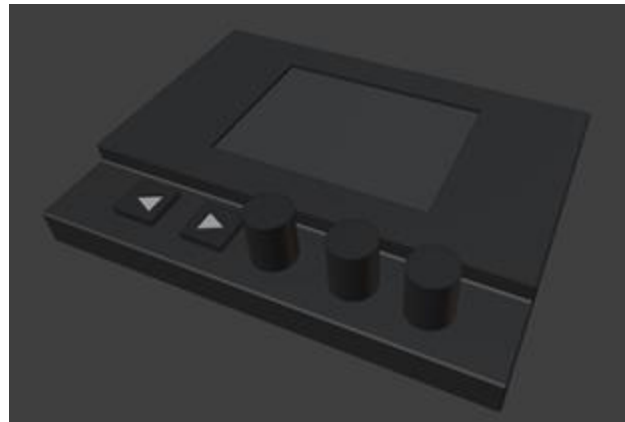
ECE477 MIDTERM DESIGN REVIEW: TEAM #12

OUTLINE

- Project Overview
- Major Components
- Block Diagram
- Packaging Design
- Electrical Schematic
- PCB Layout
- Prototyping Progress
- Software Development Status
- Project Timeline
- Questions

PROJECT OVERVIEW

- Apply digital signal processing effects to audio from an external microphone
 - Equalization
 - Delay
 - Distortion
- Audio input and output via TRS jacks
- Provide user interface via LCD screen, rotary encoders, and buttons



PSDRS

- PSDR #1 (Hardware): An ability to send and receive an audio signal to and from a codec and a microcontroller via I2S.
- PSDR #2 (Software): An ability to apply five band EQ, distortion, and delay effects via DSP on an input audio.
- PSDR #3 (Hardware): An ability to control DSP parameters using input to a microcontroller from a set of rotary encoders and buttons.
- PSDR #4 (Hardware): An ability for the microcontroller to interface with an LCD display via SPI.
- PSDR #5 (Software): An ability to provide a GUI to display DSP parameters and corresponding audio effects.

Stretch PSDRS:

- PSDR #6 (hardware): An ability to control parameters and interact with the user interface via capacitive touch screen.
- PSDR #7 (hardware): An ability to send output audio data to a computer via USB.

MAJOR COMPONENTS

Microcontroller

Selected: STM32F746ZGT6

- 216 MHz clock
- 320 KB SRAM
- 4 x I2C
- 3 x I2S
- 3.3v

Alternative: STM32F407

- 168 MHz clock
 - 192 KB SRAM
 - 3 x I2C
 - 2 x I2S
 - 3.3v
- Also briefly considered PIC32
 - Preferred STM32 because of familiarity



MAJOR COMPONENTS

Voltage Regulator and USB Connector

LD1117S33TR

- Low dropout Voltage
- 5V to 3.3V
- Output up to 800 mA
- 10 uF capacitor minimum
- $\pm 1\%$ at 25 °C



USB2.0 MICRO B SMD

- 5V, 500 mA



MAJOR COMPONENTS

Codec

Selected: WM8731

- 3.3v
- 2 x I2S up to 32 bit
- ADC/DAC up to 96kHz
- Built in amplifier
- QFN package
- Dev board available

Alternative: CS4272

- 5.0v
- 2 x I2S up to 24 bit
- ADC/DAC up to 192kHz
- Requires external amplification
- SSOP package
- No dev board



MAJOR COMPONENTS

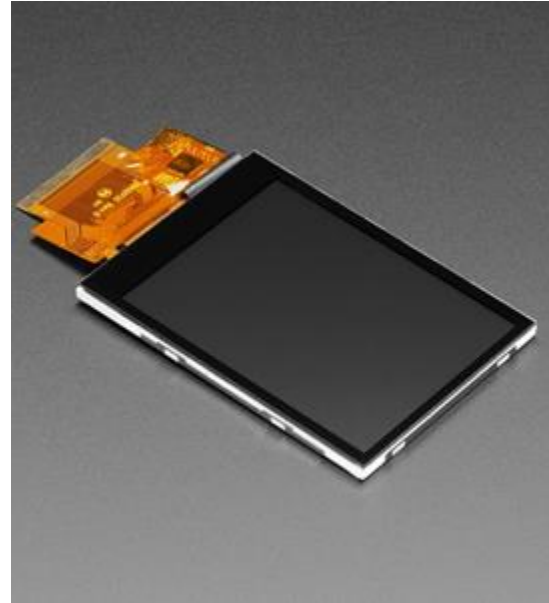
Screen

Selected: CH280QV10-CT

- 2.8" TFT w/ Capacitive Touch
- 240x320 (RGB)
- TFT Driver IC: ILI9341V (SPI)
- CTP Driver IC: CST026 (I2C)
- 3.3V
- [Adafruit Breakout Board](#)

Alternative: CH500WV05A-T

- 5.0" TFT w/ Resistive Touch
- 800x480 (RGB)
- 24-bit Parallel RGB Interface
- 3.3V



MAJOR COMPONENTS

Rotary Encoders and Buttons

Rotary Encoders: PEC11R-4215F-S0024

- Quadrature Incremental Rotary Encoders
- 24 Pulses Per Revolution
- 3D printed knobs

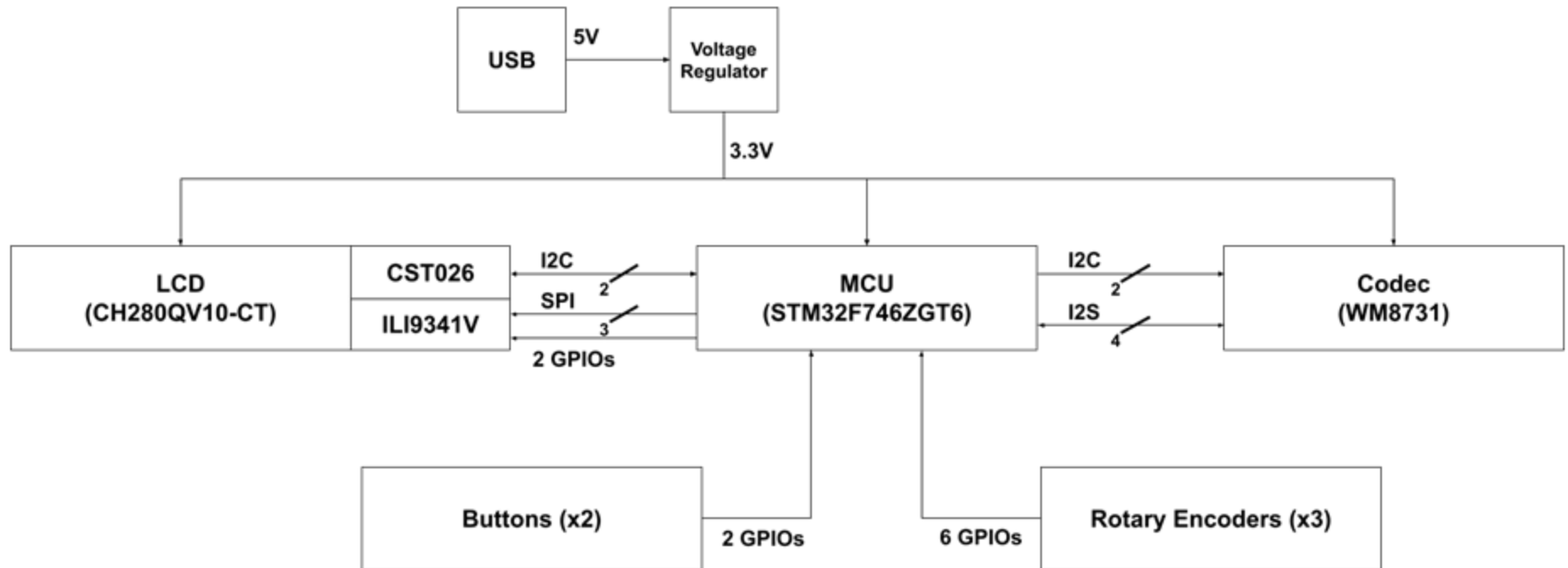


Buttons: B3F-4050

- Operating Force: 130gf
- Pull-Down
- 3D printed caps

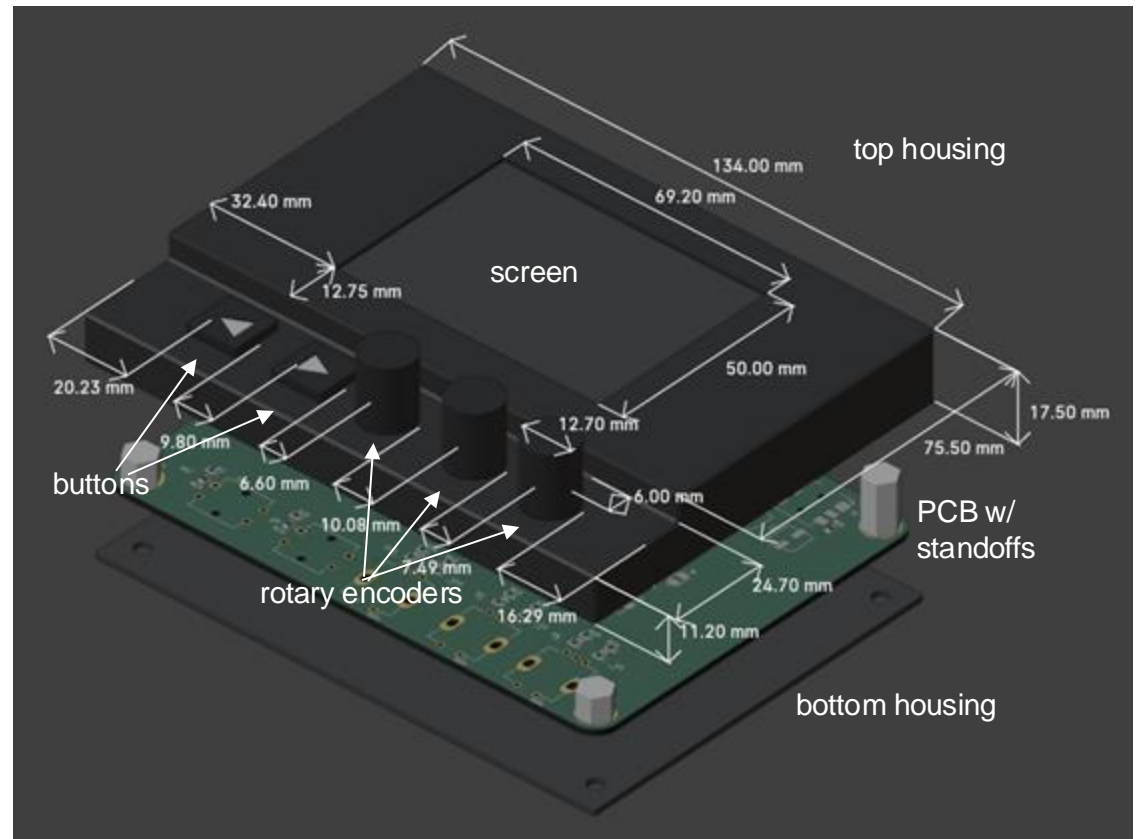


BLOCK DIAGRAM



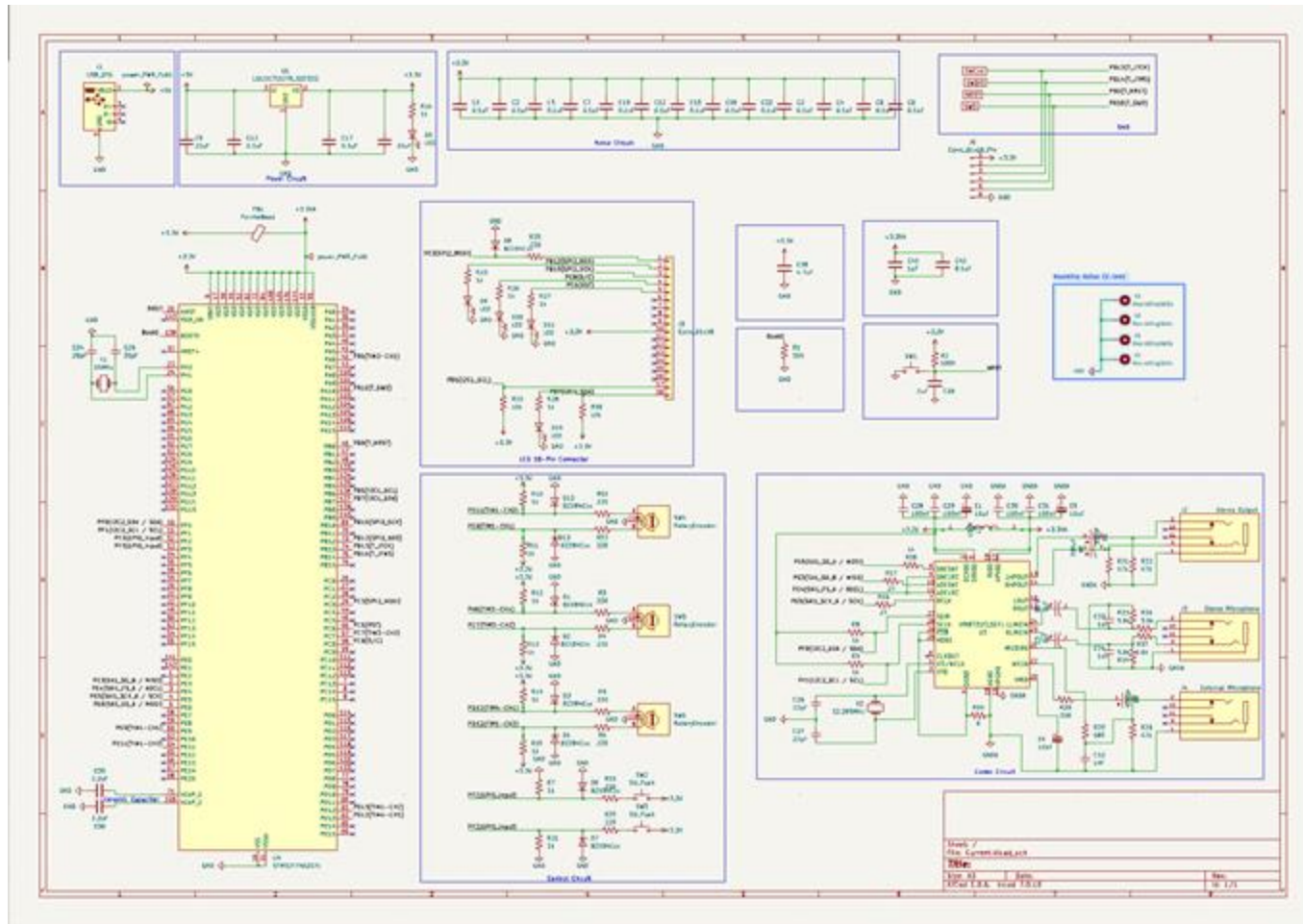
PACKAGING DESIGN

- 3D printed housing
- Nylon standoffs glued to top
- Screws through back plate
- Holes for ports in back



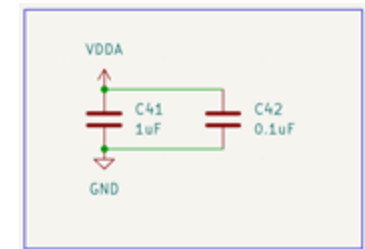
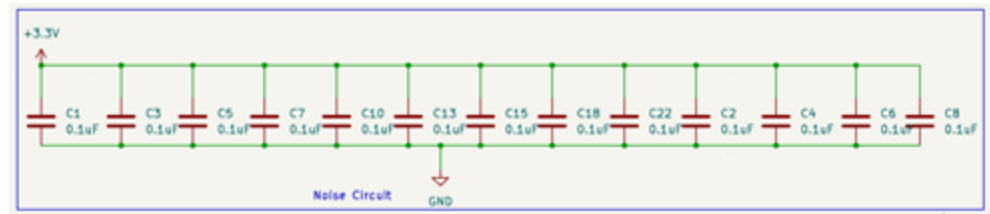
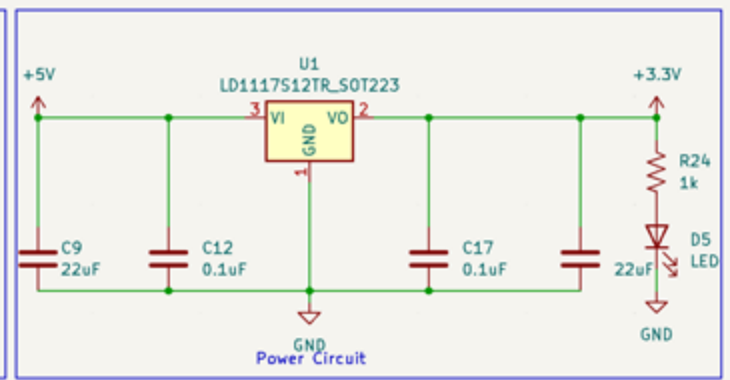
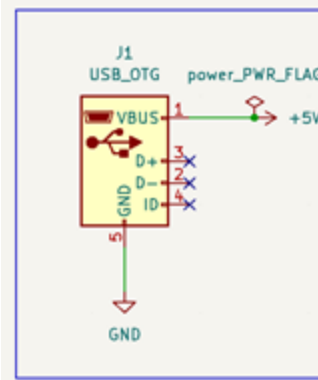
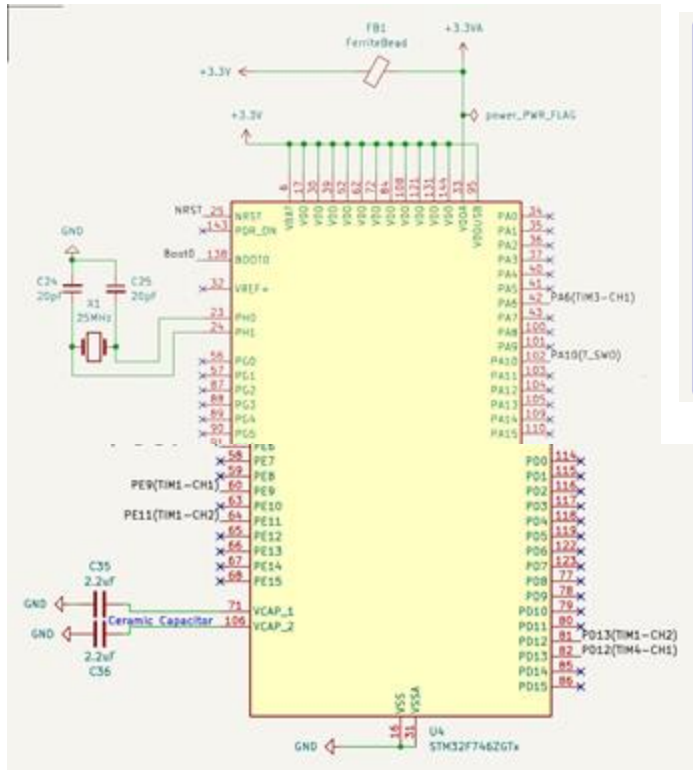
ELECTRICAL SCHEMATIC

General Overview



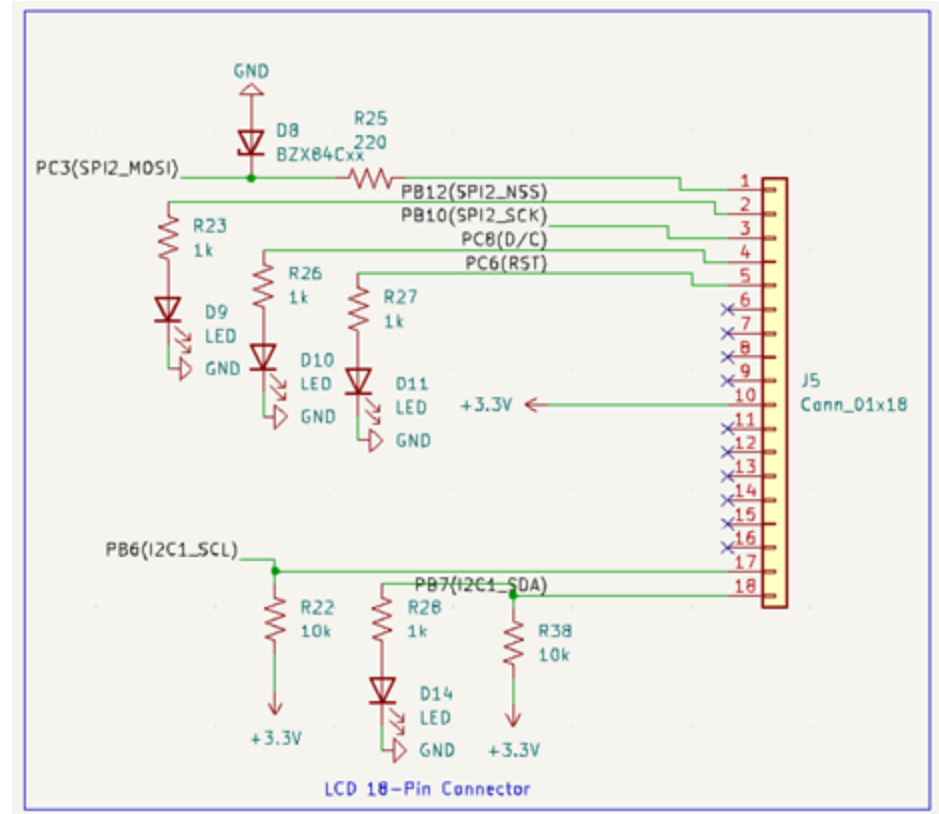
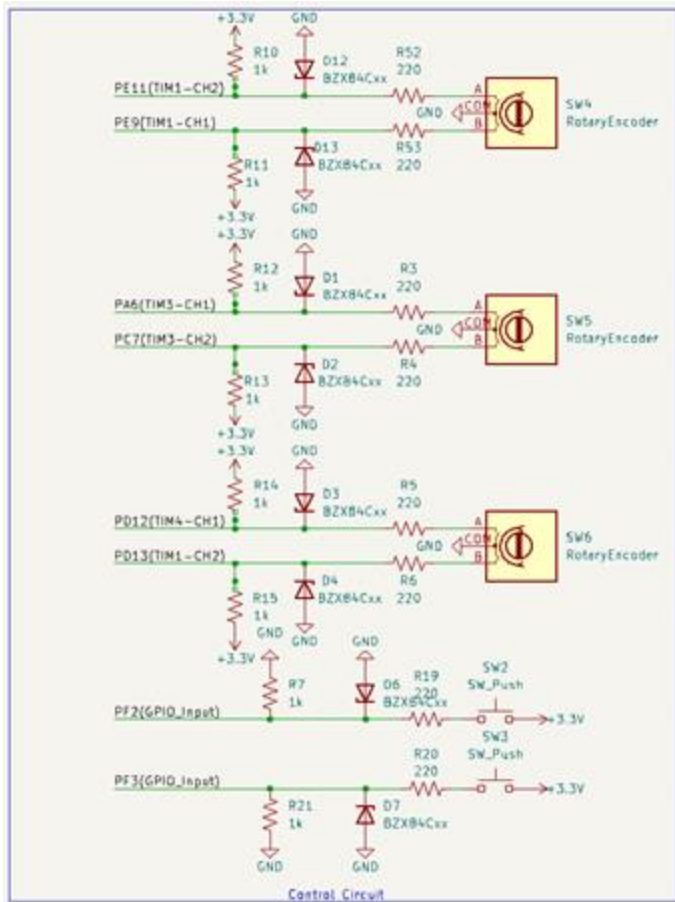
ELECTRICAL SCHEMATIC

MCU



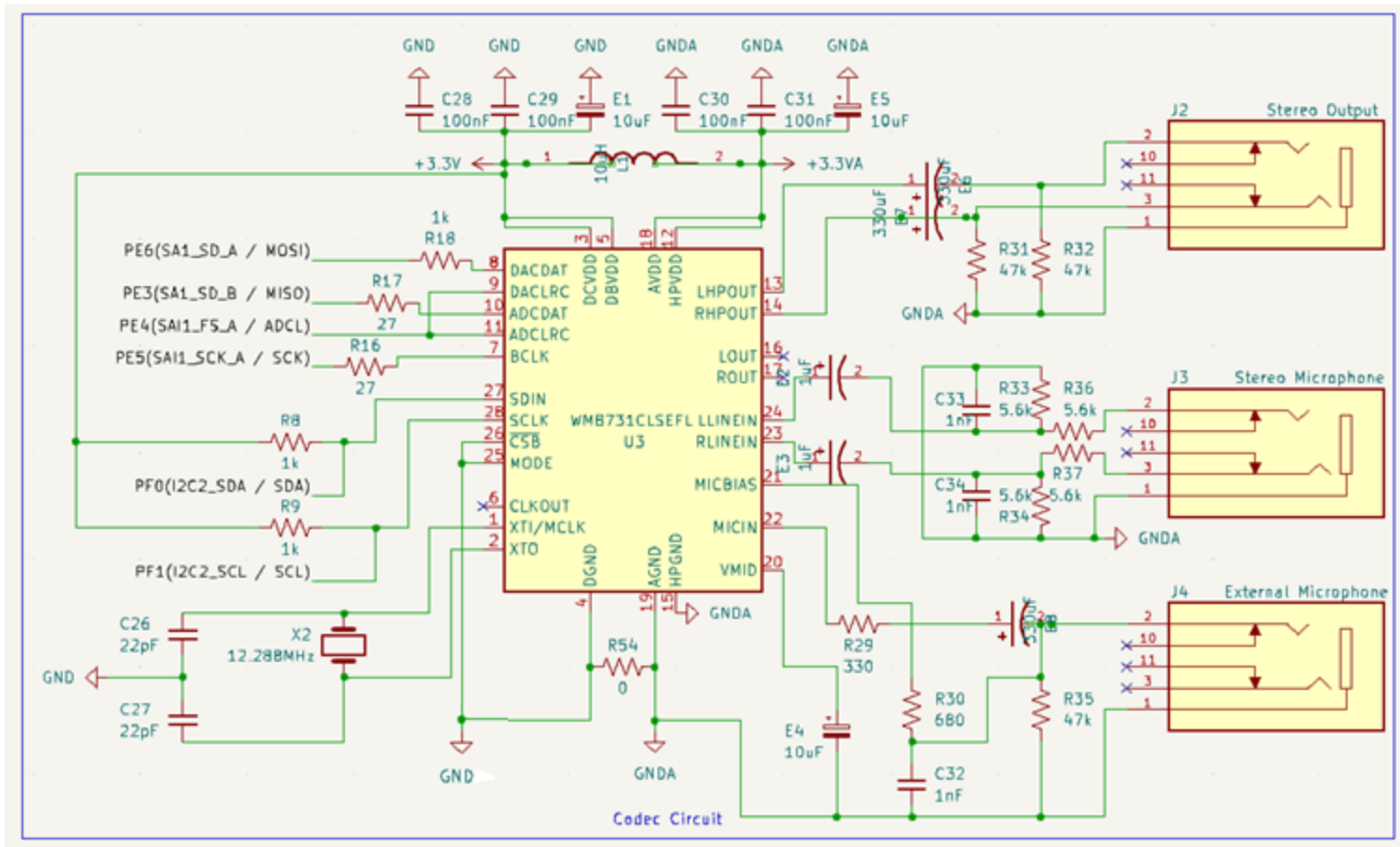
ELECTRICAL SCHEMATIC

Controls and LCD



ELECTRICAL SCHEMATIC

Codec



PCB LAYOUT

General Overview

Length: 130mm

Width: 95.2mm

Layers: 4

Trace Width:

0.3mm

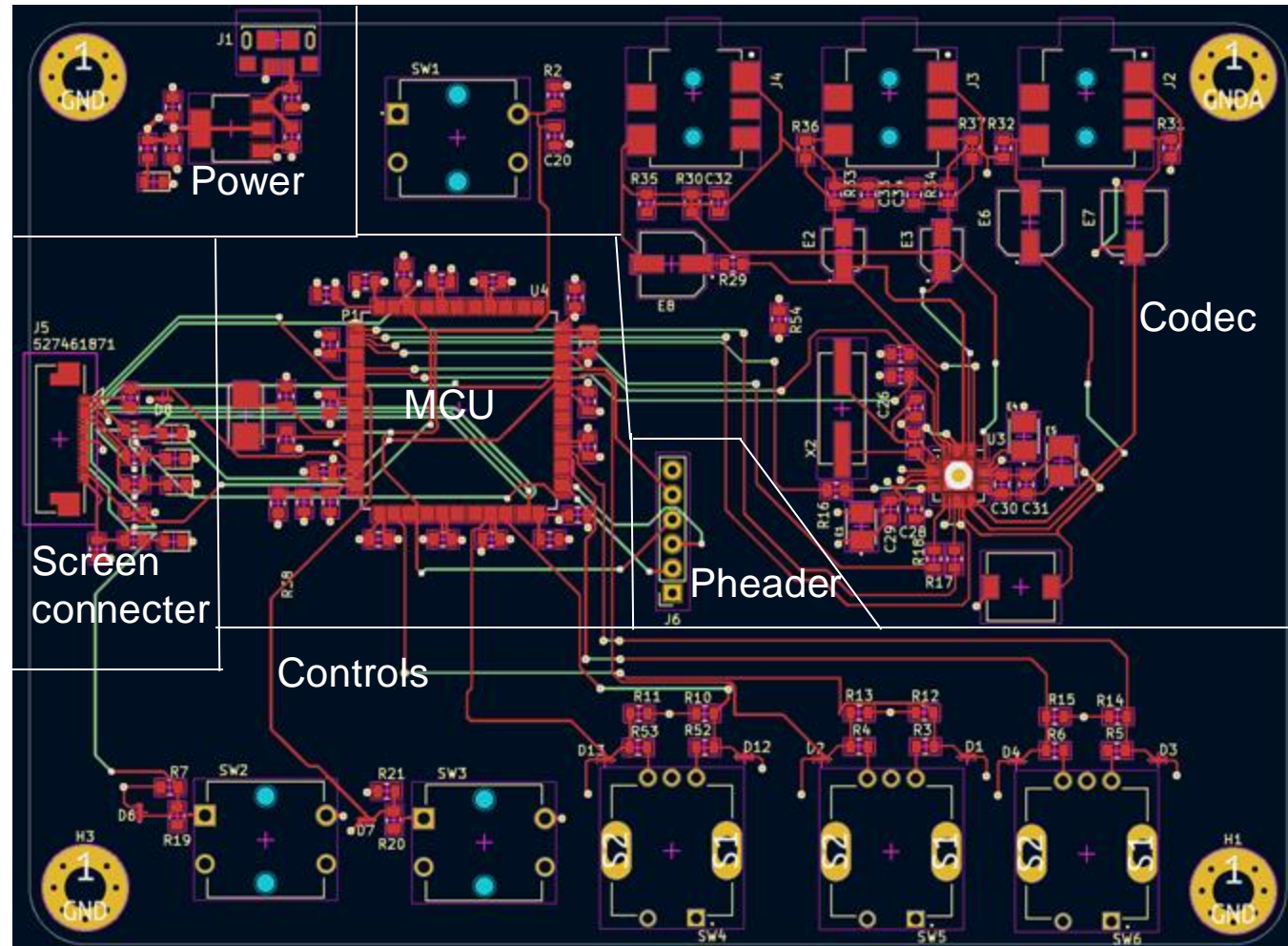
0.5mm

Mounting Holes: 4

Vias:

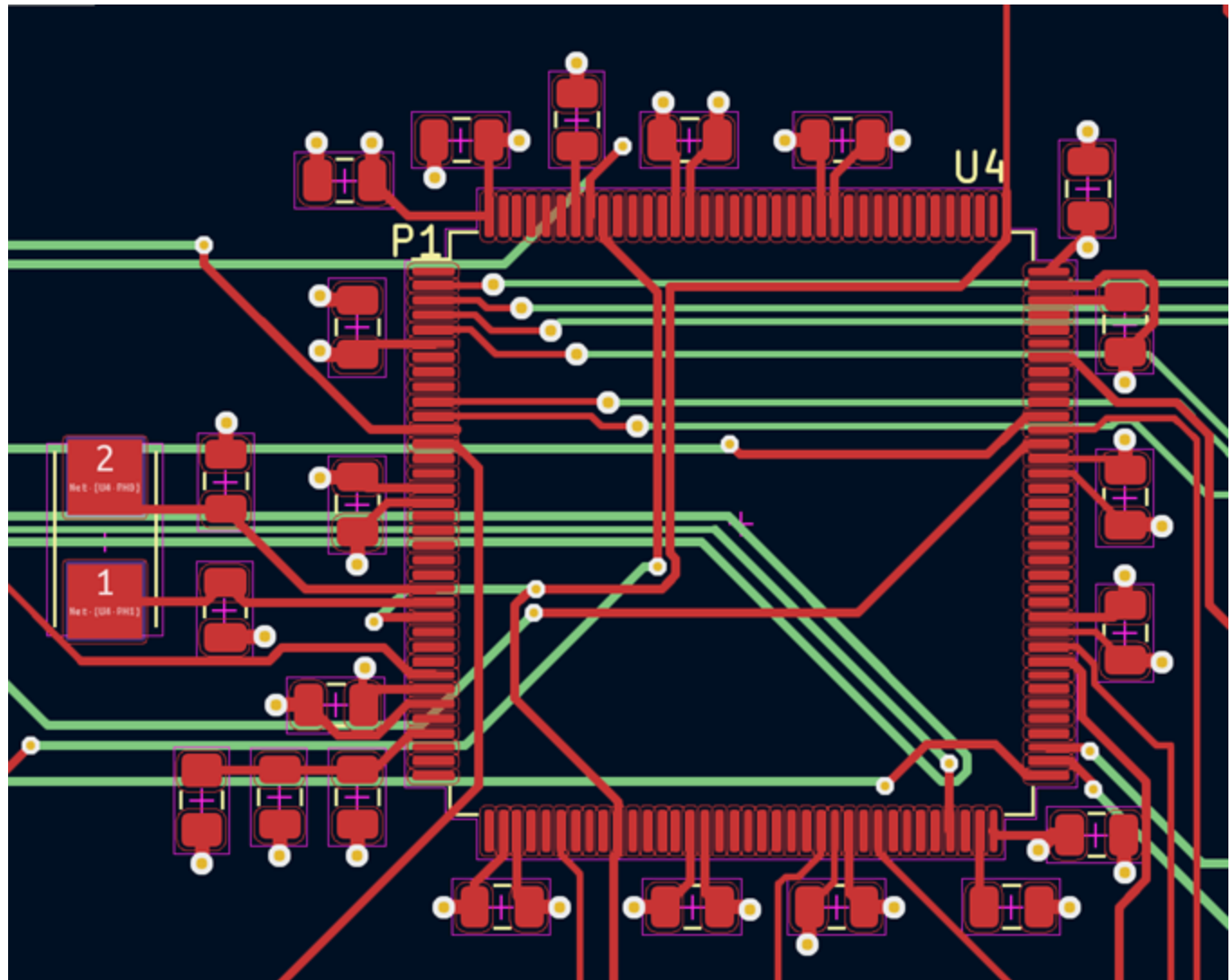
0.8mm

0.4mm



PCB LAYOUT

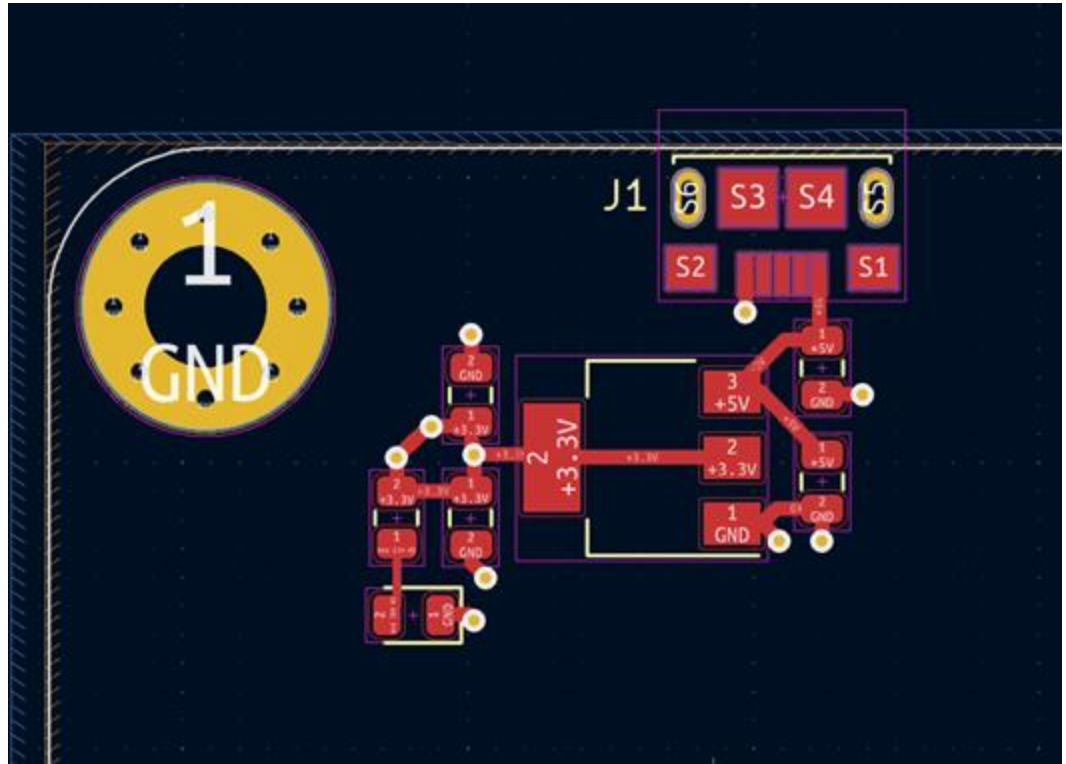
MCU



PCB LAYOUT

Power

Trace Width: 0.5mm

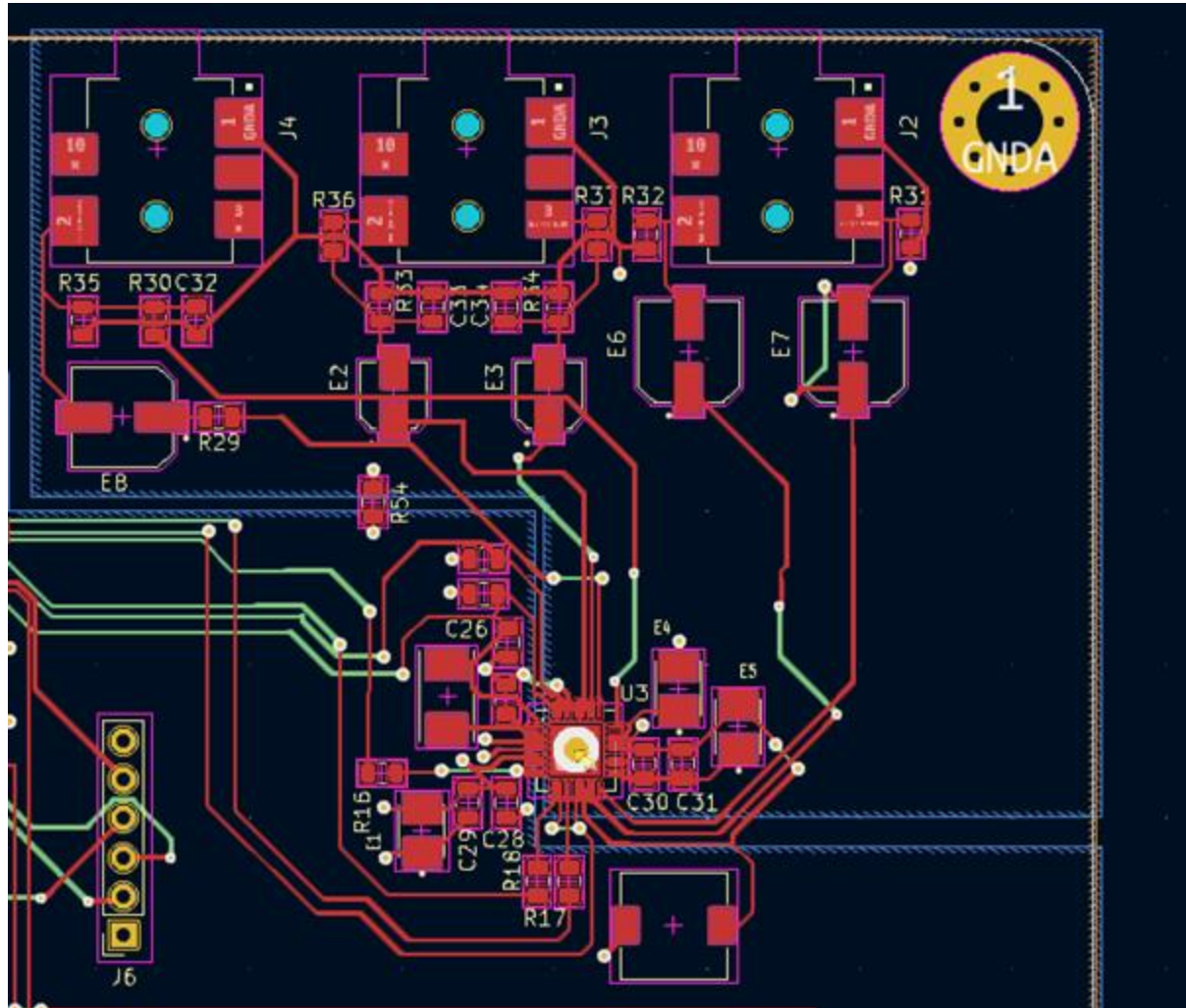


PCB LAYOUT

Codec

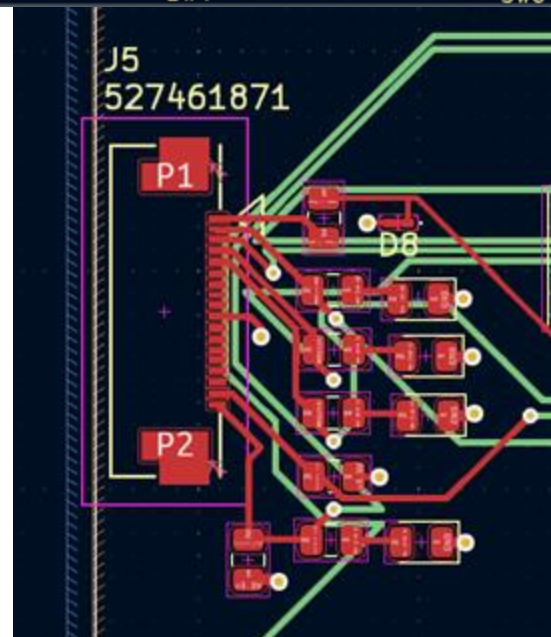
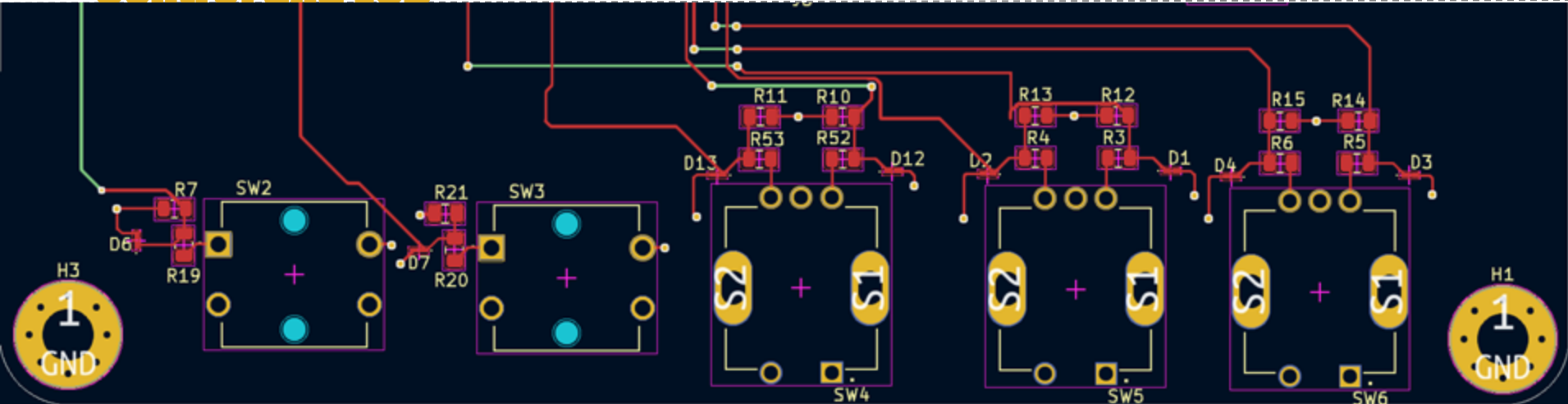
Separate analog ground plane

Via under QFN codec



PCB LAYOUT

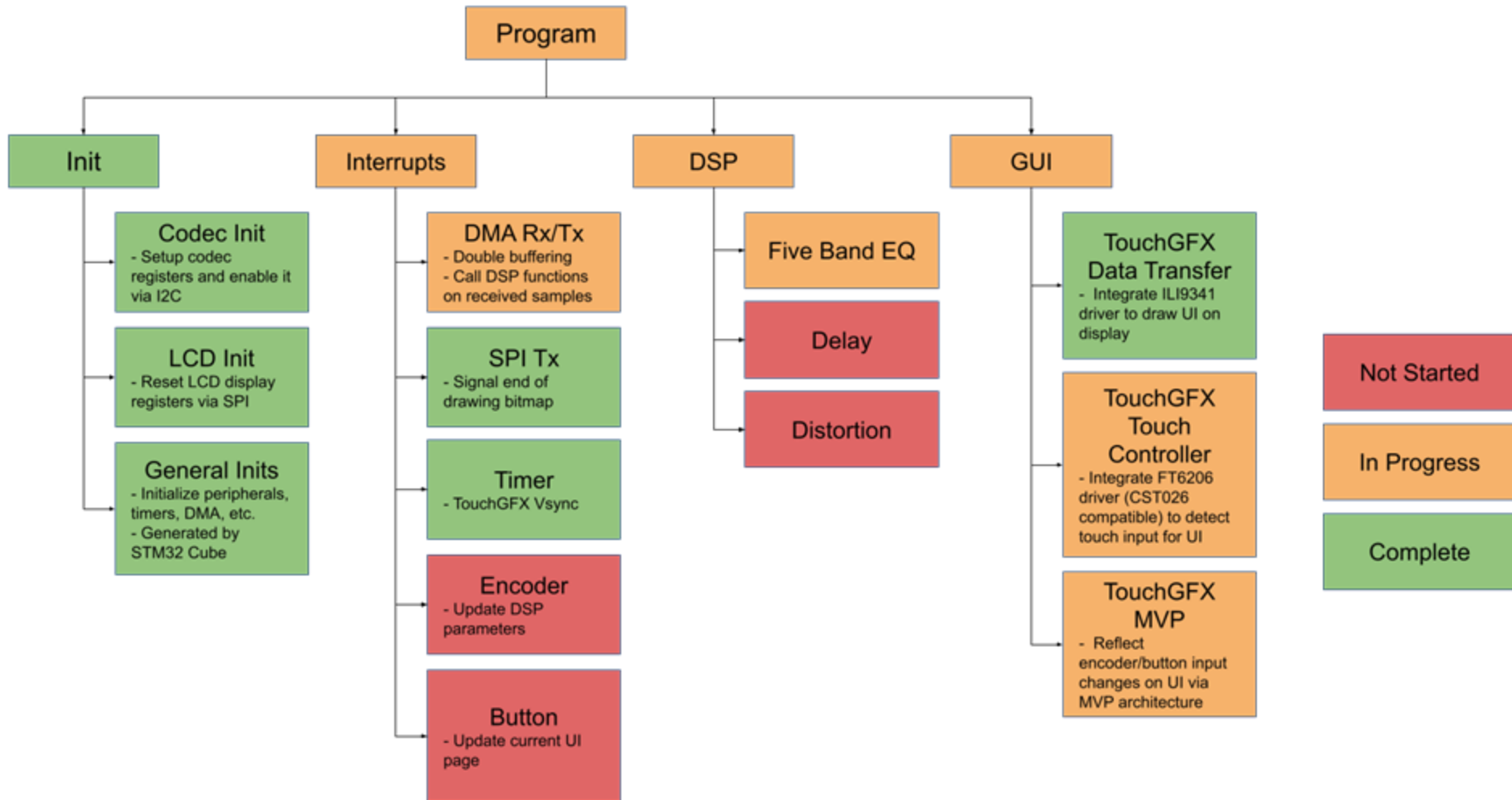
Control and LCD



PROTOTYPING PROGRESS

- Power Circuit
 - Prototyped and fully tested on laptop and desktop port
- Touchscreen
 - Successfully interfaced dev board with STM32F7
 - Custom demo ran on it
- Codec
 - Successfully interfaced dev board with STM32F7
 - Custom setup driver written
 - Audio issues resolved
- Controls
 - Prototyped and tested on breadboard with STM32F4

SOFTWARE DEVELOPMENT STATUS



PROJECT TIMELINE

| | March 3rd-10th | March 11th-17th | March 18th-24th | March 25th-30th | April 1st-7th | April 8th-14th | April 15th-21st | April 22nd-28th |
|-----------------------------------|----------------|-----------------|-----------------|-----------------|---------------|----------------|-----------------|-----------------|
| Task | Week 9 | Week 10 | Week 11 | Week 12 | Week 13 | Week 14 | Week 15 | Week 16 |
| PCB Revision | | | | | | | | |
| Touch Controller Prototyping | | | | | | | | |
| UI Design | | | | | | | | |
| DSP FX Development | | | | | | | | |
| PCB Assembly / Testing | | | | | | | | |
| Firmware Development | | | | | | | | |
| Component Integration and Testing | | | | | | | | |
| Packaging | | | | | | | | |
| End User Testing | | | | | | | | |
| Final Presentation | | | | | | | | |

Questions?